## DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

DOCKETNO, TS02-360

As a below named Inventor, I hereby declare that:

Post Office Address

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only ne name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Improved Adhesion Of CU And Etch Stop Layer For CU Alloy

the specification of which (check one)			
X is attached hereto.			
was filed on			_
Application Serial No.			_
and was amended on(if a	nalicobles		_
I hereby state that I have reviewed and u amended by any amendment referred to	rideismid me editeilm of die v	bove Identified specification includi	ng the claims, as
I acknowledge the duty to disclose informatile 37, Code of Federal Regulations, §	mation which is material to the 1.56(a).	examination of this application in ac	cordance with
I hereby claim foreign priority benefits u inventor's certificate listed below and ha having a filing date before that of the app Prior Foreign Application(s)	nder Title 35, United States Co we also identified below any fo plication on which priority is ch	ode §119 of any foreign application(s oreign application for patent or invent laimed:	) for patent or tor's certificate
		Priority Claim	ied:
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit under Title 35, as the subject matter of each of the claim manner provided by the first paragraph o information as defined in Title 37, Code application and the national or PCT inter	United States Code §120 of a soft this application is not disc of Title 35. United States Code, of Federal Regulations, §1.56(mational filing date of this applications)	ny United States application(s) listed losed in the prior United States appli §112, I acknowledge the duty to disc a) which occurred between the filing lication:	below and, insofar cation in the close material date of the prior
(Application Scrial No.)	(Filing Date) (Status)	(patented, pending, abandoned)	
I hereby declare that all statements made belief are believed to be true; and further the like so made are punishable by fine o and that such willful false statements ma	herein of my own knowledge: that these statements were may imprisonment, or both, under y jeopardize the validity of the	are true and that all statements made de with the knowledge that willful far r Section 1001 of Title 18 of the Unit application or any patent issued ther	on information and lse statements and ted States Code son.
POWER OF ATTORNEY: As a named application and transact all business in the	inventor, I hereby appoint the f ne Patent and Trademark Office	following attorney(s) and/or agent(s) e connected therewith. (list name & r	to prosecute this egistration no.)
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